



Product Change Notification

Change Notification #: 118913-00
Change Title: MINOR CHANGE,
Select Intel® Xeon® Platinum and Intel®
Xeon® Gold Processors,
PCN 118913-00, Manufacturing Site, Label,
Add second site for Assembly, Test and Finish
Manufacturing
Date of Publication: March 04, 2022

Key Characteristics of the Change:

Manufacturing Site, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material	May 20, 2022
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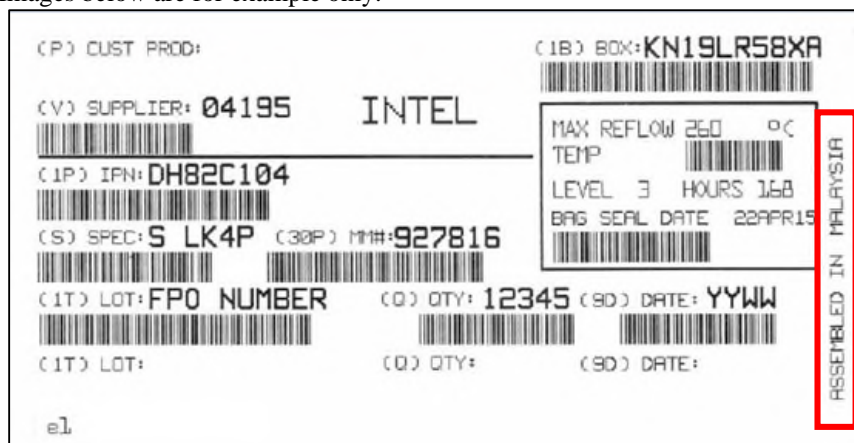
Description of Change to the Customer:

Intel is certifying an additional Manufacturing Site in Costa Rica to enable both full flow manufacturing (Assembly, Test, and Finish) & partial manufacturing for the products listed in the Products Affected / Intel Ordering Codes table below.

Costa Rica manufacturing will begin on the date specified in the Forecasted Key Milestones table above. Customers can expect to receive material from either the Costa Rica or Malaysia manufacturing sites.

The "Assembled in" value displayed on box labels will now reflect either "Malaysia" or "Costa Rica".

Images below are for example only.



(P) CUST PROD:	(1B) BOX: KN19LR58XA
(V) SUPPLIER: 04195 INTEL	MAX REFLOW 260 °C TEMP
(1P) IPN: DH82C104	LEVEL 3 HOURS 168
(S) SPEC: S LK4P (38P) MM#: 927816	BAG SEAL DATE 22APR15
(1T) LOT: FPO NUMBER	(Q) QTY: 12345 (90) DATE: YYWW
(1T) LOT:	(Q) QTY:
	(90) DATE:

el

ASSEMBLED IN COSTA RICA

Customer Impact of Change and Recommended Action:

Intel considers this change a MINOR CHANGE. There is no change to the form, fit, functionality, quality or reliability for the products. All manufacturing sites are certified equivalent (form, fit, function, and reliability) for the affected products and technologies of this change.

Customers should notify their receiving department to expect shipments from any one of our qualified manufacturing sites in Malaysia or Costa Rica.

Please contact your Intel Representative for any questions or concerns.

Products Affected/Intel Ordering Codes:

Marketing Name	MM#	Product Code	Spec Code
Intel® Xeon® Gold 5318H Processor	99A0H3	CD8070604481600	S RJGD
Intel® Xeon® Platinum 8380H Processor	99A33D	CD8070604480301	S RJXQ
Intel® Xeon® Platinum 8380HL Processor	99A33N	CD8070604480401	S RJXR
Intel® Xeon® Platinum 8376H Processor	99A33P	CD8070604480501	S RJXS
Intel® Xeon® Platinum 8376HL Processor	99A33R	CD8070604480601	S RJXT
Intel® Xeon® Gold 6348H Processor	99A34A	CD8070604481101	S RJXX
Intel® Xeon® Gold 6328H Processor	99A34C	CD8070604481201	S RJXY
Intel® Xeon® Gold 6328HL Processor	99A34D	CD8070604481301	S RJXZ
Intel® Xeon® Gold 5320H Processor	99A34G	CD8070604481501	S RJY1
Intel® Xeon® Platinum 8353H Processor	99A34H	CD8070604481601	S RJY2
Intel® Xeon® Gold 5318H Processor	99A34K	CD8070604481600	S RJY3
Intel® Xeon® Platinum 8356H Processor	99A643	CD8070604559701	S RK57
Intel® Xeon® Platinum 8360HL Processor	99A646	CD8070604559801	S RK58
Intel® Xeon® Platinum 8360H Processor	99A64A	CD8070604559900	S RK59
Intel® Xeon® Gold 6330H Processor	99A64C	CD8070604560002	S RK5A
Intel® Xeon® Platinum 8354H Processor	99A677	CD8070604481002	S RK5Y

PCN Revision History:

Date of Revision:

March 04, 2022

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

118913-00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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